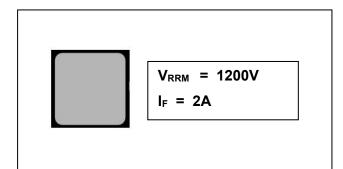


SD4-1200-S002AB SiC Schottky Power Rectifier Chip



Description

- 1200-Volt Schottky Rectifier
- Zero Reverse Recovery
- Zero Forward Recovery
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Positive Temperature Coefficient on VF

Part Number	Die Size	Anode	Cathode
SD4-1200-S002AB	Please contact your sales representative to get the detailed information about die layout and dimensions.	AI	Ag

Maximum Ratings:

Parameter	Symbol	Value	Units
Repetitive Peak Reverse Voltage	VRRM	1200	V
Surge Peak Reverse Voltage	V _{RSM}	1200	V
DC Peak Blocking Voltage	V _R	1200	V
Maximum DC Current	I _F	2	A
Non-Repetitive Forward Surge Current	IFSM	44	A
Operating Junction and Storage Temperature	T_J , T_stg	-55 to +175	°C
Maximum Procesing Temperature	T _{Proc}	325	°C

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Electrical Characteristics(T=25℃ unless otherwise specified):

Parameter	Symbol	Condition	Тур.	Max.	Units
DC Forward Voltage	VF	I _F = 2 A, TJ=25°C	1.5	1.8	V
		I _F = 2 A, TJ=175°C	1.9	2.5	V
Reverse Current	I _R	V _R = 1200 V, T _J =25°C	1	25	uA
		V _R = 1200 V, T _J =175°C	20	35	uA
Junction Capacitance	Ст	V _R =0V, T _J =25℃,f=1MHz	160	-	Ст
Reverse Recovery Charge	0	I _F = 2A, di/dt = 200A/μs	12.33	-	0
	Qc	V _R = 800 V, T _J =25°C			Qc
Capacitance Stored Energy	Ec	V _R = 800 V, T _J =25°C	6.33	-	Ec

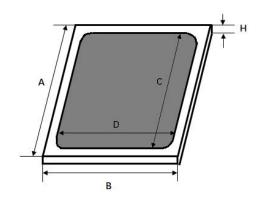
* Pulse width < 300 μ s, duty cycle < 2%

Mechanical Parameters:

Parameter	Тур.	Unit
Die Size	1.20×1.20	mm
Anode Pad opening	0.75×0.75	mm
Thickness	350±10%	μm
Wafer Size	152.4	mm
Anode Metalization (Al)	4	μm
Cathode Metalization (Ag)	0.4	μm
Frontside Passivation	Polyimide	



Dimension



symbol	Dimension +/- 10%
A	1.20 mm
В	1.20 mm
С	0.75 mm
D	0.75 mm
н	350 um

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